Document Number: G2MAH0110-15 Preliminary Datasheet V1.0

## 0.1-1.0GHz,2 stages, 15W, 28V GaN Fully matched PA Module

### **Description**

The G2MAH0110-15 is a 15-watt ,2 stage integrated Power Amplifier Module, designed for broad band applications, with frequencies from 100MHz to 1.0GHz. The module is 50  $\Omega$  input/output matched and requires minimal external components.



The module implements distributed power amplifier in form of multi chips, housed in cost effective plastic open cavity package, offers a much lower cost than traditional MMIC solutions.

Vds=28V, Idq1=10 mA, Idq2=40 mA, CW

Parameter	0.1GHz	0.3GHz	0.5GHz	0.7GHz	0.9GHz	1.0GHz	Units
Linear Gain	29.0	26.7	26. 2	25.6	25.8	25.7	dB
Gain@Pin=19dBm	23.5	23.6	23.8	23.4	23.3	23.5	dB
Pout@Pin=19dBm	18.4	18.3	18.9	17.2	17.2	17.7	W
PAE@Pin=19dBm	64	63	61	56	56	55	%

#### **Product Features**

• Operating Frequency Range: 0.1-1.0GHz

• Operating Drain Voltage: +28 V (Up to 32V)

• 50 Ω Input/Output

• Psat: ≥15W @28V, ≥20W @32V

• Small signal gain:>25dB, Power gain:>23dB @Pin=19dBm

• Minimum efficiency:>50%

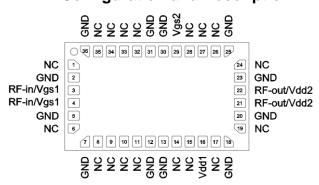
• 6x10 mm Surface Mount Package

• Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

### **Applications**

- Ultra Broadband Amplifiers
- Fiber Drivers
- Test Instrumentation
- EMC Amplifier Drivers
- 2-way Radios

### **Pin Configuration and Description**





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Pin No.	Symbol	Description	
21,22	RFout/Vdd2	Transistor 1, Drain Bias2 & RF Output	
3,4	RFin/Vgs1	Transistor 1, Gate Bias1 & RF Input	
29	Vgs2	Transistor 1, Gate Bias2	
16	Vdd1	Transistor 1, Drain Bias1	
Others	NC	No connection	
2,5,7,12, 13,18,20,23,25, 30, 31,36 Package Base GN		DC/RF Ground. Must be soldered to EVB ground plane over array of vias for thermal and RF performance. Solder voids under Pkg Base will result in excessive junction temperatures causing permanent damage.	

### **Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	150	Vdc
GateSource Voltage	V <sub>GS</sub>	-10 to +2	Vdc
Operating Voltage	V <sub>DD</sub>	+36	Vdc
Input CW Power	RFin	22	dBm
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C

### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case, FEA	Do 10	4.7	°C/W
T <sub>C</sub> = 25°C, DC test	Rejc	4.7	-C/vv

### **Table 3. Electrical Characteristics**

Parameter	Condition	Min	Тур	Max	Unit
Frequency Range		100		1000	MHz
Power Gain		23			dB
Роит	Pin=19dBm		42		dBm
Drain Efficiency @ P <sub>SAT</sub>		50			%
Unless otherwise noted: TA = 25°C, V <sub>DD</sub> =28 V, Pulse Width=100 us, Duty cycle=10%					

Load Mismatch of per Section (On Test Fixture, 50 ohm system):  $V_{DD} = 28 \text{ V}$ ,  $I_{DQ1+2} = 10+40 \text{ mA}$ , f = 1 GHz

VSWR 10:1 at pulse CW Output Power @Pin=22dBm	No Device Degradation
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## Reference Circuit of Test Fixture Assembly Diagram

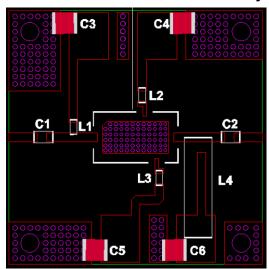


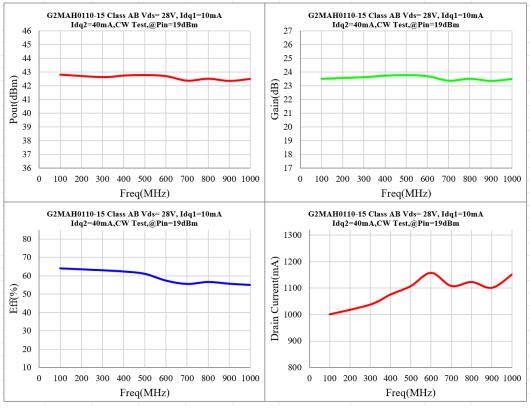
Figure 1. Test Circuit Component Layout

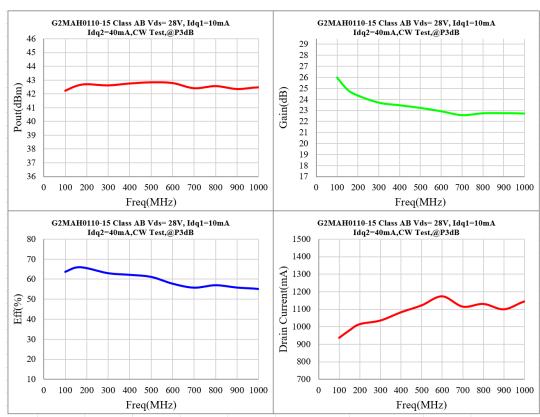
		Part NO.	Vendor
C1, C2	50V 1uF Chip Capacitor	GRM21BR71H105KA12L	muRata
C3,C4,C5,C6	10uF 100V Chip Capacitor	C5750X7S2A106M230KB	TDK
L1, L2,L3	100 nH Capacitor(0603)	LQW18CNR10K00D	muRata
L4	1.3uH 4.2A Inductor	4310LC-132KEC	Coilcraft
PCB	RO4350B,20mil,er=3.48		



### TYPICAL CHARACTERISTICS

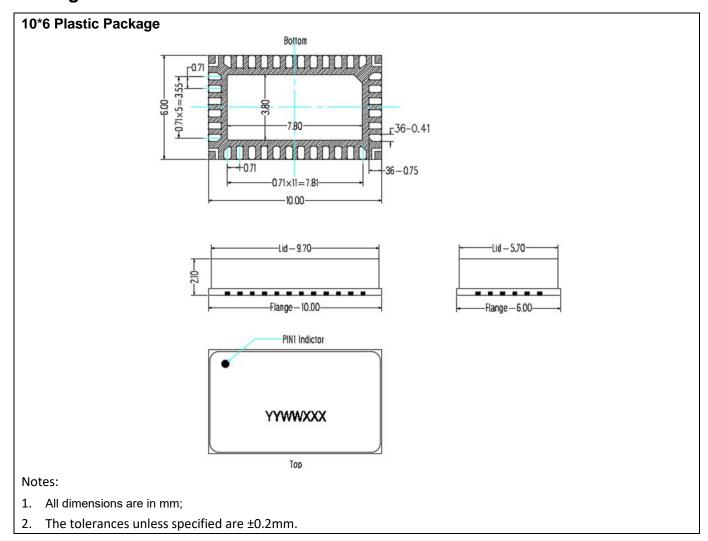
Figure 3. Power Gain and, efficiency and Pout @Pin=19dBm, P3dB vs. Frequency



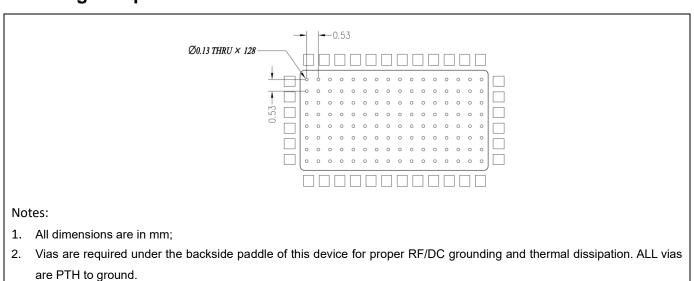


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## **Package Dimensions**



## **Mounting Footprint Pattern**





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### **Revision history**

#### Table 6. Document revision history

Date	Revision	Datasheet Status
2025/5/20	Rev 1.0	Preliminary datasheet creation by highlighting 0.1-1GHz performance

Application data based on ZHH-25-09

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